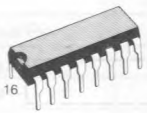
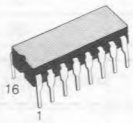
3 TO 8 LINE DECODER/LATCH (INVERTING)

- HIGH SPEED
  t_{PD} = 14 ns (TYP.) at V_{CC} = 5V
- LOW POWER DISSIPATION
  I_{CC} = 4 μA (MAX.) at T_A = 25°C
- HIGH NOISE IMMUNITY
  $V_{NIH} = V_{NIL}$ = 28% V_{CC} (MIN.)
- OUTPUT DRIVE CAPABILITY
  10 LSTTL LOADS
- SYMMETRICAL OUTPUT IMPEDANCE
  $|I_{OH}| = I_{OL}$ = 4 mA (MIN.)
- BALANCED PROPAGATION DELAYS
  $t_{PLH} = t_{PHL}$
- WIDE OPERATING VOLTAGE RANGE
  V_{CC} (OPR) = 2V to 6V
- PIN AND FUNCTION COMPATIBLE
  WITH 54/74LS137



B1N
Plastic Package



F1
Ceramic Frit Seal Package

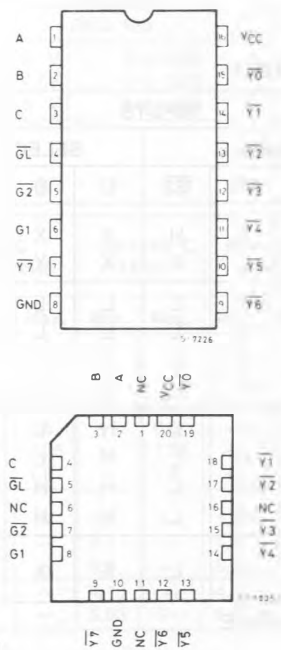
M1
Micro Package

C1
Plastic Chip Carrier

ORDERING NUMBERS:

M54HC137 F1
M74HC137 B1N
M74HC137 F1
M74HC137 C1
M74HC137 M1

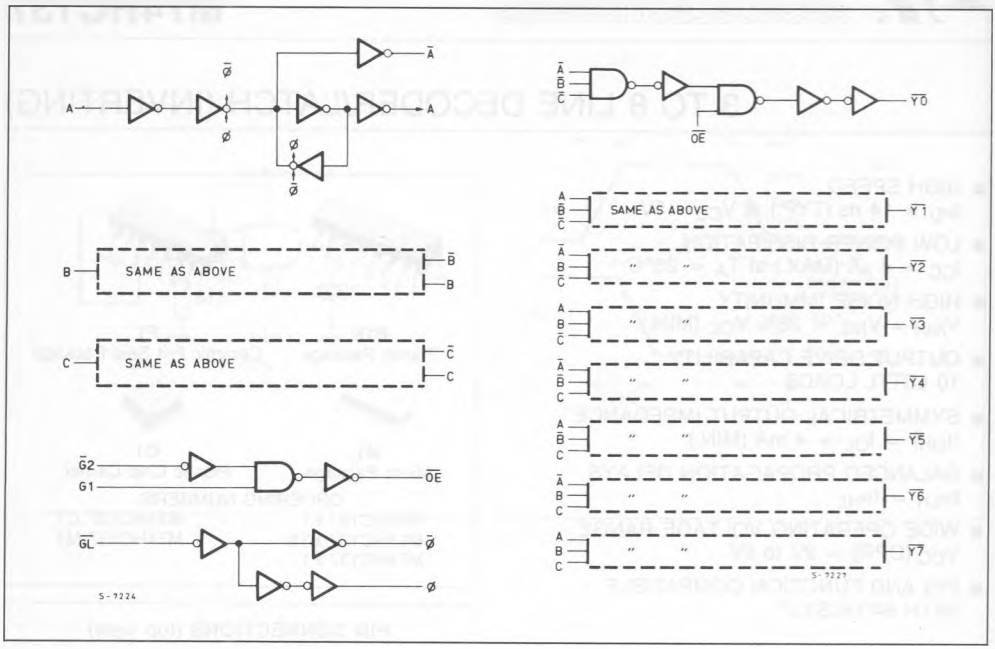
PIN CONNECTIONS (top view)



DESCRIPTION

The M54/74HC137 is a high speed CMOS 3 TO 8 LINE DECODER/LATCH (INVERTING) fabricated in silicon gate C²MOS technology. It has the same high speed performance of LSTTL combined with true CMOS low power consumption.
This device is a 3 to 8 line decoder with latches on the three address inputs. When $\overline{GL}$ goes from low to high, the address present at the select inputs (A, B and C) is stored in the latches. As long as $\overline{GL}$ remains high no address changes will be recognized. Output enable pins G1 and $\overline{G2}$, control the state of the outputs independently of the select or latch-enable inputs. All the outputs are high unless G1 and $\overline{G2}$ are low. The HC137 is ideally suited for the implementation of glitch-free decoders in stored-address applications in bus oriented systems.
All inputs are equipped with protection circuits against static discharge and transient excess voltage.

LOGIC DIAGRAM



TRUTH TABLE

INPUTS						OUTPUTS							
ENABLE			SELECT										
$\overline{GL}$	G1	$\overline{G2}$	C	B	A	$\overline{Y0}$	$\overline{Y1}$	$\overline{Y2}$	$\overline{Y3}$	$\overline{Y4}$	$\overline{Y5}$	$\overline{Y6}$	$\overline{Y7}$
X	X	H	X	X	X	H	H	H	H	H	H	H	H
X	L	X	X	X	X	H	H	H	H	H	H	H	H
L	H	L	L	L	L	L	H	H	H	H	H	H	H
L	H	L	L	L	H	H	L	H	H	H	H	H	H
L	H	L	L	H	L	H	H	L	H	H	H	H	H
L	H	L	L	H	H	H	H	H	L	H	H	H	H
L	H	L	H	L	L	H	H	H	H	L	H	H	H
L	H	L	H	L	H	H	H	H	H	H	L	H	H
L	H	L	H	H	L	H	H	H	H	H	H	L	H
L	H	L	H	H	H	H	H	H	H	H	H	H	L
H	H	L	X	X	X	Outputs corresponding to stored address L: all others H							

X: DON'T CARE

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	−0.5 to 7	V
V_I	DC Input Voltage	−0.5 to V_{CC} + 0.5	V
V_O	DC Output Voltage	−0.5 to V_{CC} + 0.5	V
I_{IK}	DC Input Diode Current	± 20	mA
I_{OK}	DC Output Diode Current	± 20	mA
I_O	DC Output Source Sink Current Per Output Pin	± 25	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current	± 50	mA
P_D	Power Dissipation	500 (*)	mW
T_{stg}	Storage Temperature	−65 to 150	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

(*) 500 mW: ≡ 65°C derate to 300 mW by 10 mW/°C: 65°C to 85°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Value		Unit
V_{CC}	Supply Voltage		2 to 6		V
V_I	Input Voltage		0 to V_{CC}		V
V_O	Output Voltage		0 to V_{CC}		V
T_A	Operating Temperature	74HC Series 54HC Series	−40 to 85 −55 to 125		°C
t_r, t_f	Input Rise and Fall Time	V_{CC} = 2 V V_{CC} = 4.5V V_{CC} = 6 V	0 to 1000 0 to 500 0 to 400		ns

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CC}	Test Condition		T_A = 25°C 54HC and 74HC			−40 to 85°C 74HC		−55 to 125°C 54HC		Unit
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{IH}	High Level Input Voltage	2.0 4.5 6.0			1.5 3.15 4.2	— — —	— — —	1.5 3.15 4.2	— — —	1.5 3.15 4.2	— — —	V
V_{IL}	Low Level Input Voltage	2.0 4.5 6.0			— — —	— — —	0.5 1.35 1.8	— — —	0.5 1.35 1.8	— — —	0.5 1.35 1.8	V
V_{OH}	High Level Output Voltage	2.0 4.5 6.0 4.5 6.0	V_I V_{IH} or V_{IL}	I_O −20 μA −4.0 mA −5.2 mA	1.9 4.4 5.9 4.18 5.68	2.0 4.5 6.0 4.31 5.8	— — — — —	1.9 4.4 5.9 4.13 5.63	— — — — —	1.9 4.4 5.9 4.10 5.60	— — — — —	V

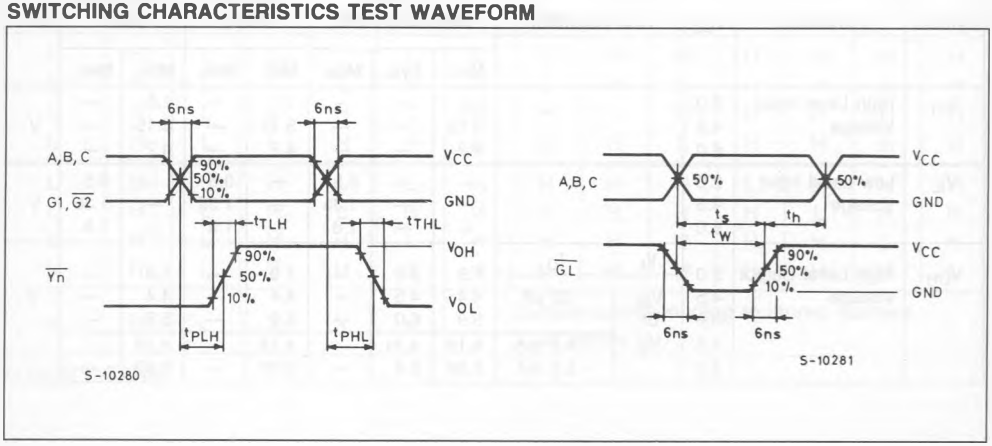
DC ELECTRICAL CHARACTERISTICS (Continued)

Symbol	Parameter	V_{CC}	Test Condition		$T_A = 25°C$ 54HC and 74HC			-40 to $85°C$ 74HC		-55 to $125°C$ 54HC		Unit
					Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V_{OL}	Low Level Output Voltage	2.0	V_I	I_O	—	0.0	0.1	—	0.1	—	0.1	V
		4.5	V_{IH} or V_{IL}	20 μA	—	0.0	0.1	—	0.1	—	0.1	
		6.0			—	0.0	0.1	—	0.1	—	0.1	
		4.5		4.0 mA	—	0.17	0.26	—	0.33	—	0.40	
		6.0		5.2 mA	—	0.18	0.26	—	0.33	—	0.40	
I_I	Input Leakage Current	6.0	$V_I = V_{CC}$ or GND		—	—	±0.1	—	±1.0	—	±1.0	μA
I_{CC}	Quiescent Supply Current	6.0	$V_I = V_{CC}$ or GND		—	—	4	—	40	—	80	μA

AC ELECTRICAL CHARACTERISTICS ($V_{CC} = 5V$, $T_A = 25°C$, $C_L = 15pF$, Input $t_r = t_f = 6ns$)

Symbol	Parameter	54HC and 74HC			Unit
		Min.	Typ.	Max.	
t_{TLH} t_{THL}	Output Transition Time		4	8	ns
t_{PLH} t_{PHL}	Propagation Delay Time (G1 - $\overline{Yn}$)		14	23	ns
t_{PLH} t_{PHL}	Propagation Delay Time ($\overline{G2}$ - $\overline{Yn}$)		17	26	ns
t_{PLH} t_{PHL}	Propagation Delay Time ($\overline{GL}$ - $\overline{Yn}$)		24	38	ns
t_{PLH} t_{PHL}	Propagation Delay Time (A,B,C - $\overline{Yn}$)		21	34	ns

SWITCHING CHARACTERISTICS TEST WAVEFORM

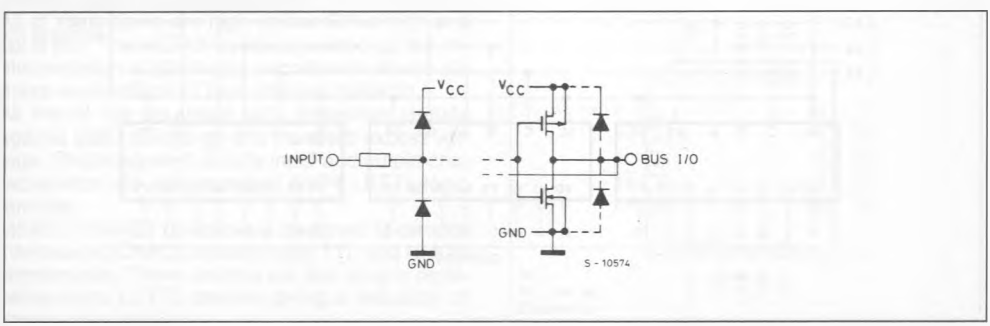


AC ELECTRICAL CHARACTERISTICS ($C_L = 50pF$, Input $t_r = t_f = 6ns$)

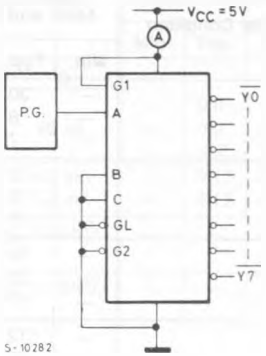
Symbol	Parameter	V_{CC}	Test Condition	T_A = 25°C 54HC and 74HC			−40 to 85°C 74HC		−55 to 125°C 54HC		Unit
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
t_{TLH} t_{THL}	Output Transition Time	2.0		—	30	75	—	95		110	ns
		4.5		—	8	15	—	19		22	
		6.0		—	7	13	—	16		19	
t_{PLH} t_{PHL}	Propagation Delay Time (G1-$\overline{Y}$n)	2.0		—	72	145	—	180		220	ns
		4.5		—	18	29	—	36		44	
		6.0		—	15	25	—	31		38	
t_{PLH} t_{PHL}	Propagation Delay Time ($\overline{G2}$-$\overline{Y}$n)	2.0		—	80	155	—	195		235	ns
		4.5		—	20	31	—	39		47	
		6.0		—	17	26	—	33		40	
t_{PLH} t_{PHL}	Propagation Delay Time ($\overline{GL}$ - $\overline{Y}$n)	2.0		—	112	220	—	275		330	ns
		4.5		—	28	44	—	55		66	
		6.0		—	24	37	—	47		56	
t_{PLH} t_{PHL}	Propagation Delay Time (A,B,C - $\overline{Y}$n)	2.0		—	100	195	—	245		295	ns
		4.5		—	25	39	—	49		59	
		6.0		—	21	33	—	42		50	
$t_{W(L)}$	Minimum Pulse Width ($\overline{GL}$)	2.0		—	30	75	—	95		110	ns
		4.5		—	8	15	—	19		22	
		6.0		—	7	13	—	16		19	
t_s	Minimum Set-up Time (A,B,C $\overline{GL}$)	2.0		—	10	50	—	65		75	ns
		4.5		—	2	10	—	13		15	
		6.0		—	2	9	—	11		13	
t_h	Minimum Hold Time (A,B,C $\overline{GL}$)	2.0		—	5	25	—	30	—	40	ns
		4.5		—	0	5	—	6	—	8	
		6.0		—	0	5	—	6	—	7	
C_{IN}	Input Capacitance			—	5	10	—	10		10	pF
C_{PD} (*)	Power Dissipation Capacitance			—	65	—	—	—			pF

Note (*) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit)
Average operating current can be obtained by the following: $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

INPUT AND OUTPUT EQUIVALENT CIRCUIT



TEST CIRCUIT I_{CC} (Opr.)



INPUT TRANSITION TIME IS THE SAME AS THAT IN CASE OF SWITCHING CHARACTERISTICS TEST

TYPICAL APPLICATION